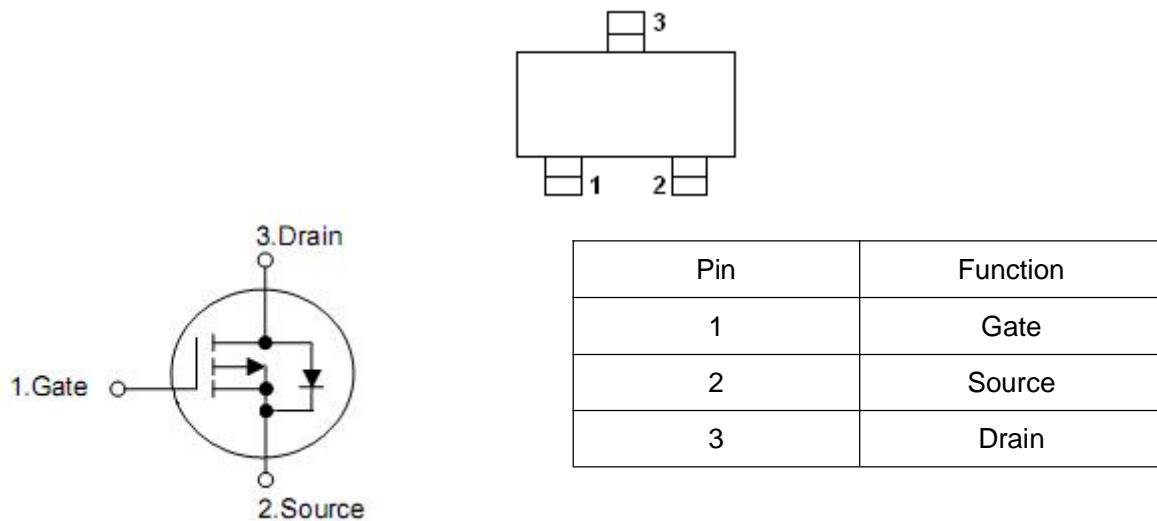


## 1. Features

- $V_{DS}=-20V, R_{DS(on)}=0.12\Omega @ V_{GS}=-4.5V, I_D=-2.8A$
- $V_{DS}=-20V, R_{DS(on)}=0.19\Omega @ V_{GS}=-2.5V, I_D=-1.8A$

## 2. Symbol



## 3. Absolute maximum ratings

Parameter	Symbol	Rating	Units
Drain-source voltage	$V_{DS}$	-20	V
Gate-source voltage	$V_{GS}$	$\pm 8$	V
Drain current continuous ( $T_J=150^\circ C$ ) <sup>b</sup>	$I_D$	-2.8	A
$T_A=70^\circ C$		-1.5	
Pulsed drain current <sup>a</sup>	$I_{DM}$	-10	
Continuous source current (diode conduction) <sup>b</sup>	$I_S$	-1.6	
Power dissipation <sup>b</sup>	$P_D$	1.25	W
$T_A=70^\circ C$		0.8	
Junction and storage temperature range	$T_J, T_{STG}$	-55 to 150	°C

Parameter	Symbol	Rating	Units
Maximum junction-ambient <sup>b</sup>	$R_{thJA}$	100	°C/W
Maximum junction-ambient <sup>c</sup>		166	

### Notes

- a. Pulse width limited by maximum junction temperature.
- b. Surface mounted on FR4 board,  $t \leq 5$  sec.
- c. Surface mounted on FR4 board.

#### 4. Electrical characteristics

( $T_J=25^\circ\text{C}$ , unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=-250\mu\text{A}$	-20	-	-	V
Gate threshold voltage*	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=-250\mu\text{A}$	-0.5	-	-1.0	V
Gate- body leakage	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 8\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}}=-16\text{V}, V_{\text{GS}}=0\text{V}$	-	-	-50	nA
On-state drain current <sup>a</sup>	$I_{\text{D}(\text{on})}$	$V_{\text{DS}} \leq -5\text{V}, V_{\text{GS}}=-4.5\text{V}$	-6	-	-	A
		$V_{\text{DS}} \leq -5\text{V}, V_{\text{GS}}=-2.5\text{V}$	-3	-	-	
Static drain-source on-resistance <sup>a</sup>	$R_{\text{DS}(\text{on})}$	$V_{\text{GS}}=-4.5\text{V}, I_{\text{D}}=-2.8\text{A}$	-	0.105	0.12	$\Omega$
		$V_{\text{GS}}=-2.5\text{V}, I_{\text{D}}=-1.8\text{A}$	-	0.145	0.19	
Forward transconductance <sup>a</sup>	$g_{\text{fs}}$	$V_{\text{DS}}=-5\text{V}, I_{\text{D}}=-2.3\text{A}$	-	6.5	-	S
Diode forward voltage	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=-1.6\text{A}$	-	-0.8	-1.2	V
Total gate charge	$Q_g$	$V_{\text{DS}}=-6.0\text{V}, V_{\text{GS}}=-4.5\text{V}$ $I_{\text{D}}=-2.3\text{A}$	-	5.8	10	nC
Gate-source charge	$Q_{\text{gs}}$		-	0.85	-	
Gate-drain charge	$Q_{\text{gd}}$		-	1.7	-	
Input capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=-6\text{V}, V_{\text{GS}}=0\text{V},$ $f=1\text{MHz}$	-	415	-	pF
Output capacitance	$C_{\text{oss}}$		-	223	-	
Reverse transfer capacitance	$C_{\text{rss}}$		-	87	-	
Turn-on delay time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=-6\text{V}, I_{\text{D}}=-1.0\text{A},$ $R_{\text{L}}=6\Omega, R_{\text{G}}=6\Omega,$ $V_{\text{GEN}}=-4.5\text{V}$	-	13	25	ns
Rise time	$t_r$		-	36	60	
Turn-off delay time	$t_{\text{d}(\text{off})}$		-	42	70	
Fall time	$t_f$		-	34	60	

##### Notes

- a. Pulse test:pulse width $\leq 300\mu\text{s}$ ,duty cycle $\leq 2\%$

## 5. Test circuits and waveforms

